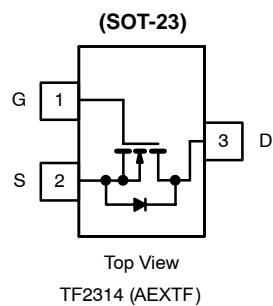


**N-Channel 20-V (D-S) MOSFET****PRODUCT SUMMARY**

V _{DS} (V)	r _{D(on)} (Ω)	I _D (A)
20	0.033 @ V _{GS} = 4.5 V	4.9
	0.040 @ V _{GS} = 2.5 V	4.4
	0.051 @ V _{GS} = 1.8 V	3.9

**ABSOLUTE MAXIMUM RATINGS (T_A = 25°C UNLESS OTHERWISE NOTED)**

Parameter	Symbol	5 sec	Steady State	Unit
Drain-Source Voltage	V _{DS}	20	±12	V
Gate-Source Voltage	V _{GS}			
Continuous Drain Current (T _J = 150°C) ^a	I _D	4.9	3.77	A
Pulsed Drain Current ^b	I _{DM}		15	
Avalanche Current ^b	I _{AS}	15	11.25	mJ
Single Avalanche Energy	E _{AS}			
Continuous Source Current (Diode Conduction) ^a	I _S	1.0	0.75	A
Power Dissipation ^a	P _D			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

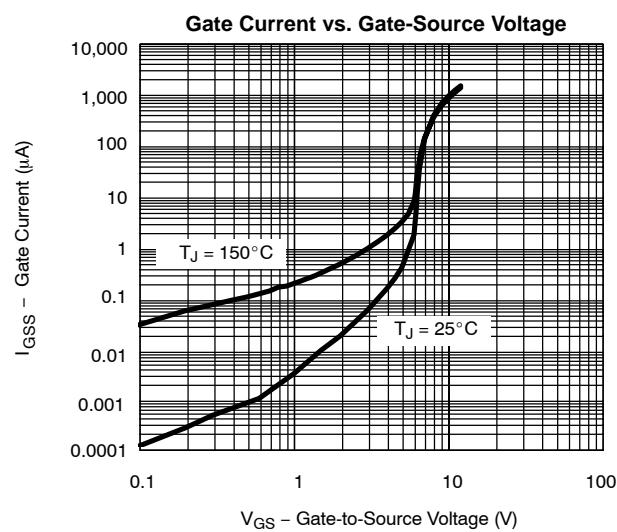
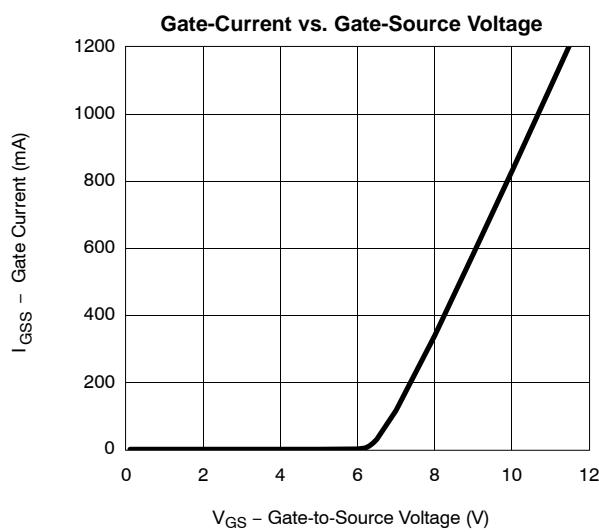
Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	t ≤ 5 sec	R _{thJA}	75	100
	Steady State		120	166
Maximum Junction-to-Foot	R _{thJF}	40	50	°C/W

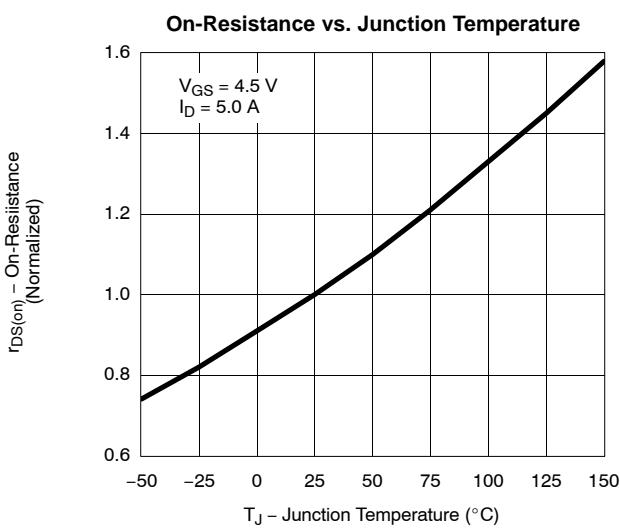
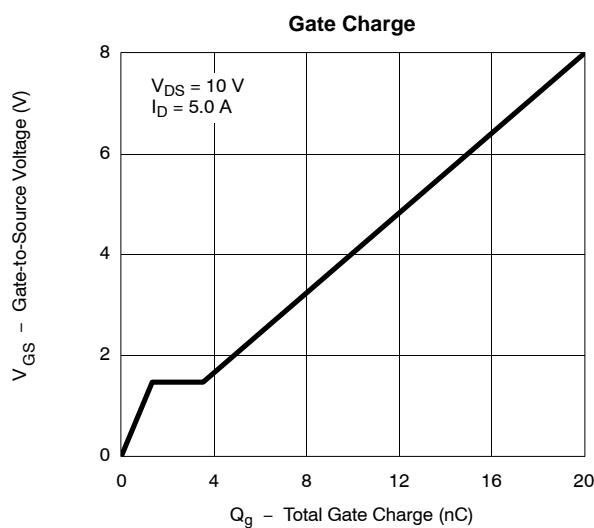
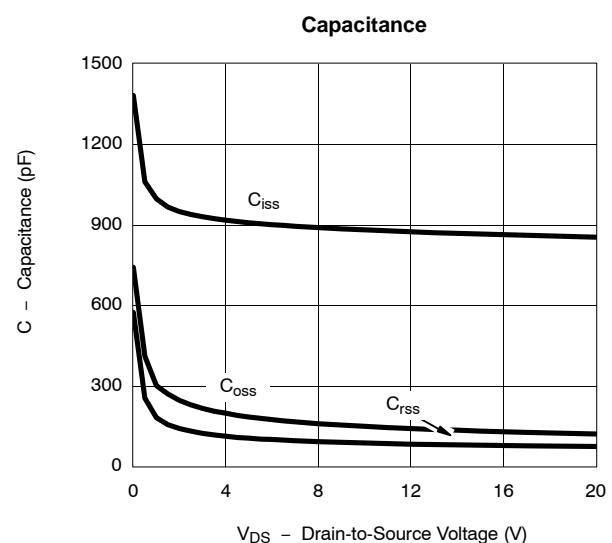
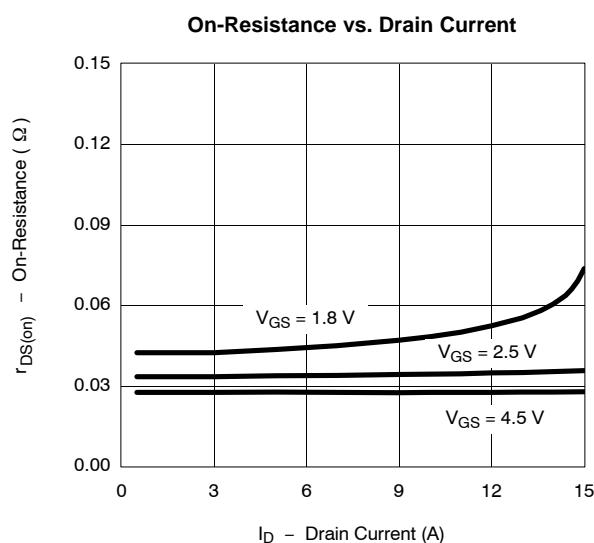
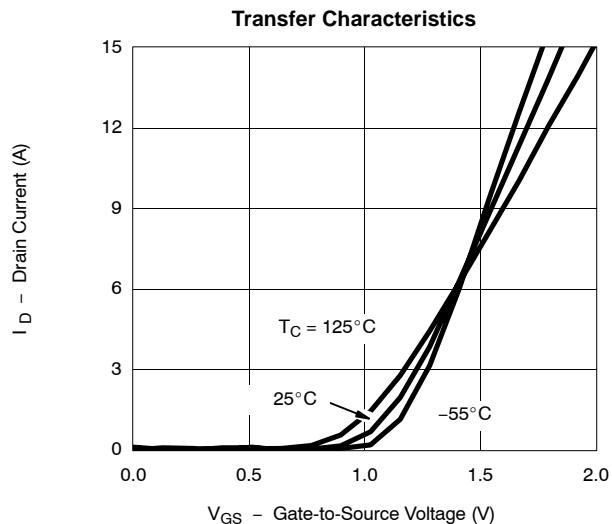
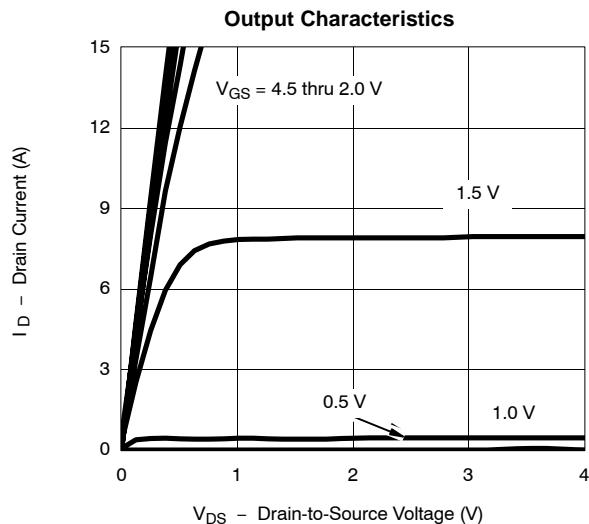
**SPECIFICATIONS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)**

Parameter	Symbol	Test Conditions	Limits			Unit
			Min	Typ	Max	
Static						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V
Gate-Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	0.45		0.95	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = \pm 12 \text{ V}$			± 1.5	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 20 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	
		$V_{\text{DS}} = 20 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 70^\circ\text{C}$			75	
On-State Drain Current ^a	$I_{\text{D}(\text{on})}$	$V_{\text{DS}} \geq 10 \text{ V}, V_{\text{GS}} = 4.5 \text{ V}$	15			A
Drain-Source On-Resistance ^a	$r_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 4.5 \text{ V}, I_D = 5.0 \text{ A}$		0.027	0.033	Ω
		$V_{\text{GS}} = 2.5 \text{ V}, I_D = 4.5 \text{ A}$		0.033	0.040	
		$V_{\text{GS}} = 1.8 \text{ V}, I_D = 4.0 \text{ A}$		0.042	0.051	
Forward Transconductance ^a	g_{fs}	$V_{\text{DS}} = 15 \text{ V}, I_D = 5.0 \text{ A}$		40		S
Diode Forward Voltage	V_{SD}	$I_S = 1.0 \text{ A}, V_{\text{GS}} = 0 \text{ V}$		0.8	1.2	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{\text{DS}} = 10 \text{ V}, V_{\text{GS}} = 4.5 \text{ V}, I_D = 5.0 \text{ A}$		11.0	14.0	nC
Gate-Source Charge	Q_{gs}			1.5		
Gate-Drain Charge	Q_{gd}			2.1		
Switching						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 10 \text{ V}, R_L = 10 \Omega$ $I_D \approx 1.0 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, R_g = 6 \Omega$		0.53	0.8	μs
Rise Time	t_r			1.4	2.2	
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			13.5	20	
Fall-Time	t_f			5.9	9	
Source-Drain Reverse Recovery Time	t_{rr}		$I_F = 1.0 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$	13	25	ns

Notes

- a. Pulse test: PW $\leq 300 \mu\text{s}$ duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

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